July 1996



SEMICONDUCTOR TM

NDT451AN N-Channel Enhancement Mode Field Effect Transistor

General Description

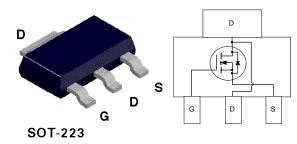
Features

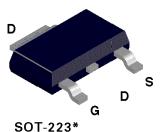
- Power SOT N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as DC motor control and DC/DC conversion where fast switching, low in-line power loss, and resistance to transients are needed.
- 7.2A, 30V. $R_{DS(ON)} = 0.035\Omega @ V_{GS} = 10V$ $R_{DS(ON)} = 0.05\Omega @ V_{GS} = 4.5V.$
- High density cell design for extremely low R_{DS(ON)}.
- High power and current handling capability in a widely used surface mount package.

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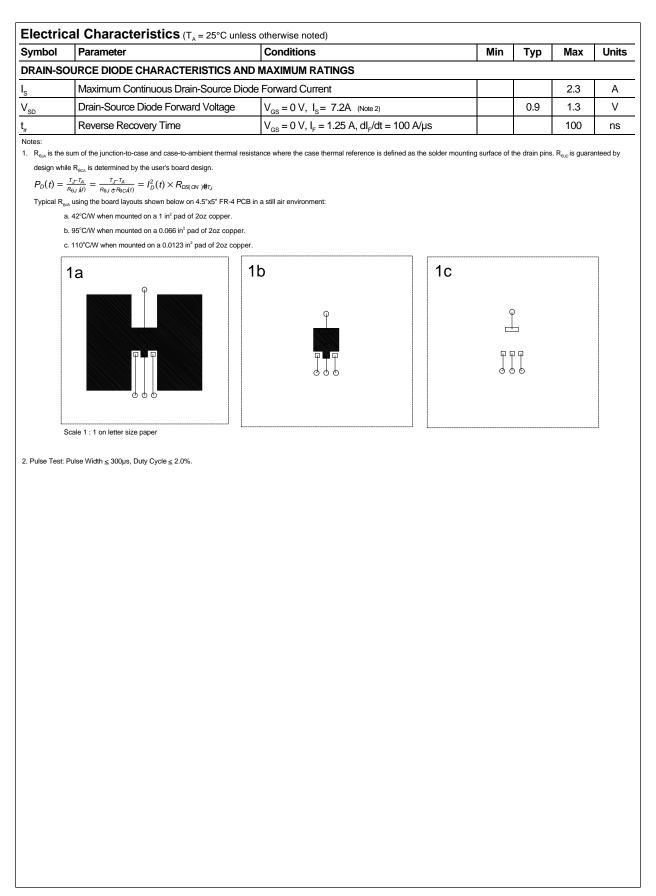


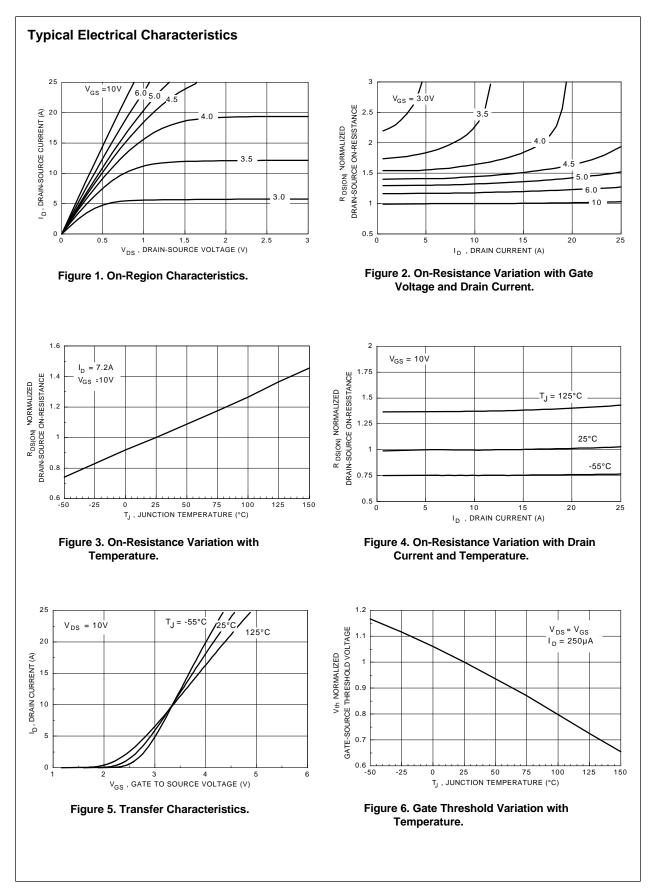
(J23Z)

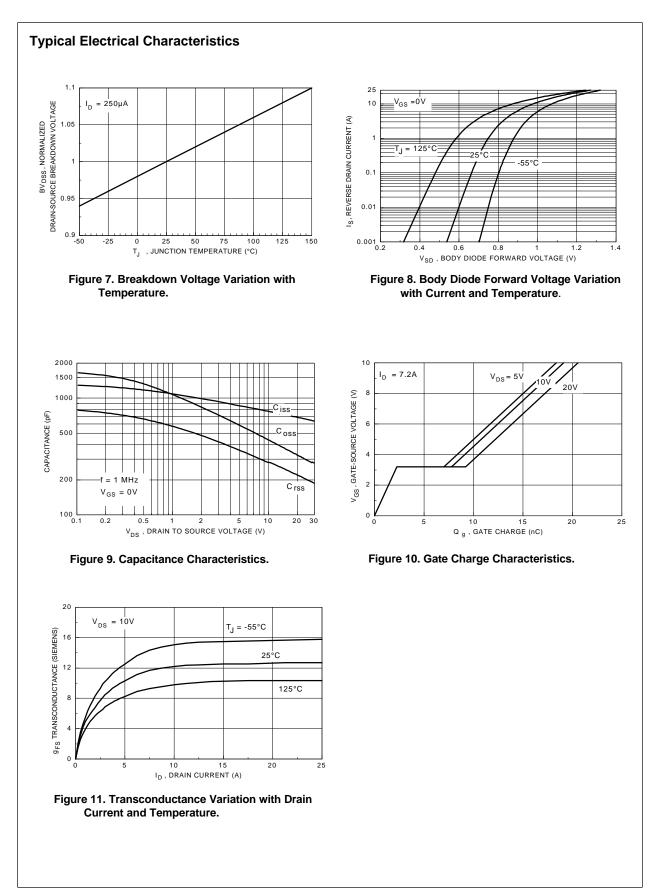
e Voltage	30 ± 20	V
	±20	
1. 0		V
nt - Continuous (Note 1a)	±7.2	A
- Pulsed	± 25	
ower Dissipation (Note 1a)	3	W
(Note 1b)	1.3	
(Note 1c)	1.1	
Id Storage Temperature Range	-65 to 150	°C
ERISTICS		
sistance, Junction-to-Ambient (Note 1a)	42	°C/W
sistance, Junction-to-Case (Note 1)	12	°C/W
n 5	ower Dissipation (Note 1a) (Note 1b) (Note 1c) Ind Storage Temperature Range ERISTICS sistance, Junction-to-Ambient (Note 1a)	ower Dissipation (Note 1a) 3 (Note 1b) 1.3 (Note 1c) 1.1 Ind Storage Temperature Range -65 to 150 ERISTICS sistance, Junction-to-Ambient (Note 1a)

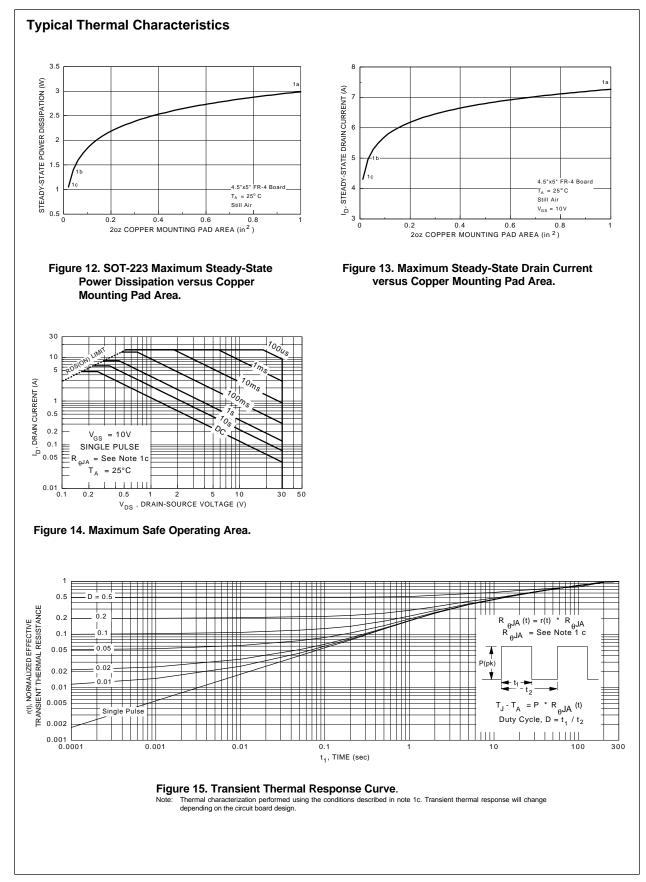
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Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		30			V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$				1	μA
			$T_J = 55^{\circ}C$			10	μA
I _{GSSF}	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
I _{GSSR}	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
ON CHAR	ACTERISTICS (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		1	1.6	3	V
			T _J = 125°C	0.7	1.2	2.2	
R _{DS(ON)} St	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7.2 \text{ A}$			0.03	0.035	Ω
			T _J = 125°C		0.042	0.063	
		$V_{GS} = 4.5 \text{ V}, I_{D} = 6.0 \text{ A}$			0.042	0.05	
			T _J = 125°C		0.058	0.09	
I _{D(on)}	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$		25			А
		$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$		15			
g _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, I_{D} = 7.2 \text{ A}$			11		S
DYNAMIC	CHARACTERISTICS						
C _{iss}	Input Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$ f = 1.0 MHz			720		pF
C _{oss}	Output Capacitance				370		pF
C _{rss}	Reverse Transfer Capacitance				250		pF
SWITCHI	IG CHARACTERISTICS (Note 2)						
t _{D(on)}	Turn - On Delay Time	$V_{\text{DD}} = 10 \text{ V}, \text{ I}_{\text{D}} = 1 \text{ A},$ $V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{GEN}} = 6 \Omega$			12	20	ns
t,	Turn - On Rise Time				13	30	ns
t _{D(off)}	Turn - Off Delay Time				29	50	ns
t _r	Turn - Off Fall Time				10	20	ns
Q _g	Total Gate Charge	$V_{DS} = 10 V,$			19	30	nC
Q _{gs}	Gate-Source Charge	$I_{\rm D} = 7.2 \text{A}, V_{\rm GS} = 10 \text{V}$			2.3		nC
Q _{gd}	Gate-Drain Charge				5.5		nC









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